**TOSHIBA** MG15Q6ES51

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

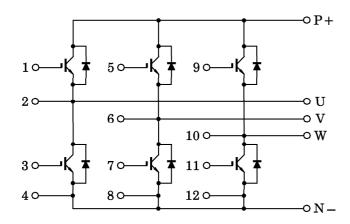
## M G 1 5 Q 6 E S 5 1

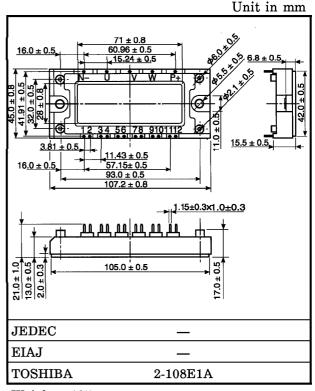
HIGH POWER SWITCHING APPLICATIONS

MOTOR CONTROL APPLICATIONS

- The Electrodes are Isolated from Case.
- High Input Impedance.
- 6 IGBTs Built Into 1 Package.

## **EQUIVALENT CIRCUIT**





Weight: 185 g

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## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Collector-Emitter Voltage		$v_{\rm CES}$	1200	V	
Gate-Emitter Voltage		$V_{ ext{GES}}$	±20	V	
Collector Current	DC	I <sub>C</sub> (25°C/80°C)	25 / 15	· A	
	1 ms	I <sub>CP</sub> (25°C/80°C)	50/30		
Forward Current	DC	$I_{\mathbf{F}}$	15	- A	
Forward Current	1 ms	$I_{ extbf{FM}}$	30		
Collector Power Dissipation (Tc = 25°C)		$P_{\mathbf{C}}$	145	W	
Junction Temperature		$T_{j}$	150	°C	
Storage Temperature Range		$ m T_{stg}$	-40~125	°C	
Isolation Voltage		$V_{Isol}$	2500 (AC 1 minute)	V	
Screw Torque		_	6	N∙m	

## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Gate Leakage Current		$I_{ ext{GES}}$	$V_{GE} = \pm 20  V,  V_{CE} = 0$	_	_	±500	nA	
Collector Cut-off Current		ICES	$V_{CE} = 1200 \text{ V}, V_{GE} = 0$	_	_	0.5	mA	
Gate-Emitter Cut-off Voltage		V <sub>GE (off)</sub>	$I_C = 15 \text{ mA}, V_{CE} = 5 \text{ V}$		6.0	_	V	
Collector-Emitter Saturation Voltage		V <sub>CE</sub> (sat)	$I_C = 15 \text{ A}, \qquad T_j = 25^{\circ}\text{C}$	_	2.8	3.2	V	
			$V_{ m GE} = 15   m V$ $T_{ m j} = 125  m ^{\circ} C$	_	3.1	3.7		
Input Capacitance		Cies	$V_{CE} = 10 \text{ V}, V_{GE} = 0,$ f = 1  MHz	_	1850	_	pF	
Switching Time	Rise Time	t <sub>r</sub>	$V_{CC} = 600 V$	_	0.07	0.15	μs	
	Turn-on Time	ton	$I_{\rm C} = 15  {\rm A},  {\rm V}_{\rm GE} = \pm 15  {\rm V}$	_	0.15	0.30		
	Fall Time	$t_f$	$R_{G} = 82 \Omega, T_{j} = 125 ^{\circ}C$	_	0.07	0.10		
	Turn-off Time	$t_{ m off}$	(Note 1)	_	0.60	0.90		
Forward Voltage		$V_{\mathbf{F}}$	$I_{F} = 15 \text{ A}, V_{GE} = 0$	_	2.0	2.8	V	
Reverse Recovery Time t		t <sub>rr</sub>	$I_{F} = 15 \text{ A}, V_{GE} = -10 \text{ V},$ $di / dt = 200 \text{ A} / \mu \text{s}$	_	0.10	0.25	μs	
Thermal Resistance		D	Transistor Stage	_	_	0.86	9G / XX	
		$ m R_{th~(j-c)}$	Diode Stage		_	1.5	°C/W	